September 2013



FGPF15N60UNDF 600 V, 15 A Short Circuit Rated IGBT

Features

- Short Circuit Rated 10us
- High Current Capability
- High Input Impedance
- Fast Switching
- · RoHS Compliant

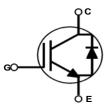
General Description

Using advanced NPT IGBT technology, Fairchild's the NPT IGBTs offer the optimum performance for low-power inverterdriven applications where low-losses and short-circuit ruggedness features are essential, such as sewing machine, CNC, motor control and home appliances.

Applications

· Sewing Machine, CNC, Home Appliances, Motor Control





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage		± 20	V	
I _C	Collector Current	@ T _C = 25°C	30	A	
	Collector Current	@ T _C = 100°C	15	A	
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	45	A	
I _F	Diode Forward Current	@ T _C = 25 ^o C	15	A	
	Diode Forward Current	@ T _C = 100°C	7.5	A	
P _D	Maximum Power Dissipation	@ T _C = 25°C	42	W	
	Maximum Power Dissipation	@ T _C = 100°C	17	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
R _{0JC} (IGBT)	Thermal Resistance, Junction to Case	-	3.0	°C/W
R _{0JC} (Diode) Thermal Resistance, Junction to Case		-	4.9	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient (PCB Mount)(2)	-	62.5	°C/W

Notes:

2: Mountde on 1" square PCB (FR4 or G-10 material)

		Package			Width	Quantity		
		TO-220F			-		50ea	
Electric	al Chai	racteristics of t	he IGBT _{Tc=}	25°C unless otherwise noted				
Symbol		Parameter	Tes	t Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics				·			
BV _{CES}	Collector	to Emitter Breakdown V	oltage V _{GE} = 0 V,	I _C = 250 μA	600	-	-	V
I _{CES}		Cut-Off Current		s, V _{GE} = 0 V	-	-	1	mA
I _{GES}	G-E Leak	age Current		$V_{CE} = 0 V$	-	-	±10	μA
On Charac	toristics				1	1		1
V _{GE(th)}		shold Voltage	I _C = 15 mA	, V _{CE} = V _{GE}	5.5	6.8	8.5	V
		0.1	-	V _{GE} = 15 V	-	2.2	2.7	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage		lter and	V _{GE} = 15 V,	-	2.7	-	V
			0	-				
Dynamic C C _{ies}	haracteris					619	1	pF
	- · · ·	apacitance	V _{CE} = 30 \	V _{CE} = 30 V, V _{GE} = 0 V,		80	_	
C _{oes}	-	Transfer Capacitance	f = 1MHz	,	-	24	-	pF pF
ores	11010100						<u> </u>	P
Switching	1						1	
t _{d(on)}		Delay Time			-	9.3	-	ns
t _r	Rise Time	9		-		9.8	-	ns
t _{d(off)}		Delay Time	$V_{\rm CC} = 400$	V, $I_{\rm C} = 15$ A,	-	54.8	-	ns
t _f	Fall Time		R _G = 10 Ω Inductive I	, V _{GE} = 15 V, .oad, T _C = 25°C	-	9.9	12.8	ns
Eon		Switching Loss			-	0.37	-	mJ
E _{off}		Switching Loss			-	0.067	-	mJ
E _{ts}		ching Loss			-	0.44	-	mJ
t _{d(on)}		Delay Time			-	8.9	-	ns
t _r	Rise Time				-	9.9	-	ns
t _{d(off)}		Delay Time		V, $I_{\rm C} = 15$ A,	-	56.6	-	ns
t _f	Fall Time			$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 125^{\circ}C$		13.2	-	ns
E _{on}		Switching Loss			-	0.54	-	mJ
E _{off}		Switching Loss			-	0.11	-	mJ
E _{ts}	Total Swit	ching Loss			-	0.65		mJ
T _{sc}	Short Circ	nort Circuit Withstand Time		V, Ω, V _{GE} = 15 V, C	10	-	-	μs

Electrical Characteristics of the IGBT $T_{C} = 25^{\circ}C$ unless otherwise noted

Qg	Total Gate Charge		-	43	-	nC
Q _{ge}	Gate to Emitter Charge	V _{CE} = 400 V, I _C = 15 A, V _{GE} = 15 V	-	6	-	nC
Q _{gc}	Gate to Collector Charge	VGE - 10 V	-	26	-	nC

Electrical Characteristics of the Diode $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM} Diode I	Diode Forward Voltage	l _F = 15 A	$T_{C} = 25^{\circ}C$	-	1.6	2.2	V
	2.040 Formard Formage		T _C = 125⁰C	-	1.5	-	
t _{rr} Diode Re	Diode Reverse Recovery Time	I _F =15 A, dI _F /dt = 200 A/μs	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	82.4		ns
11			T _C = 125⁰C	-	142	-	
Q _{rr}	Diode Reverse Recovery Charge	$r_{\rm F} = 10$ Å, $u_{\rm F}/u_{\rm c} = 200$ Å/ μ 3	$T_{C} = 25^{\circ}C$	-	213	-	nC
~11	2.edee.e.eoovory onargo		T _C = 125°C	-	541	-	

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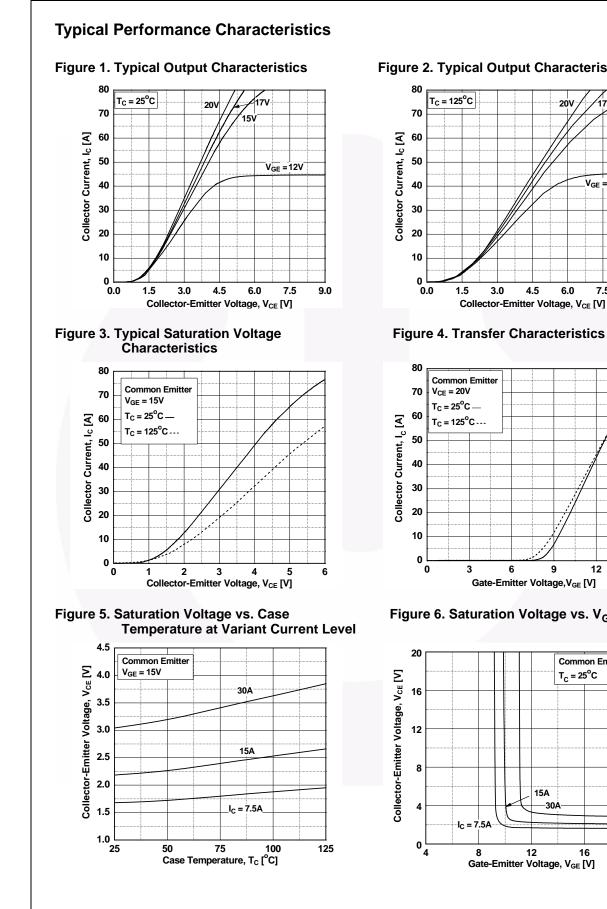


Figure 2. Typical Output Characteristics

20V

17V

V_{GE} = 12V

7.5

9.0

6.0

15V

Figure 4. Transfer Characteristics

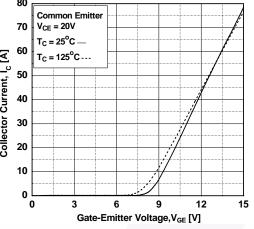
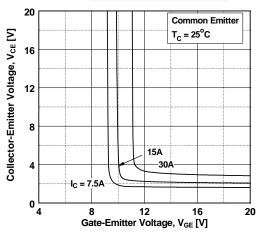


Figure 6. Saturation Voltage vs. V_{GE}



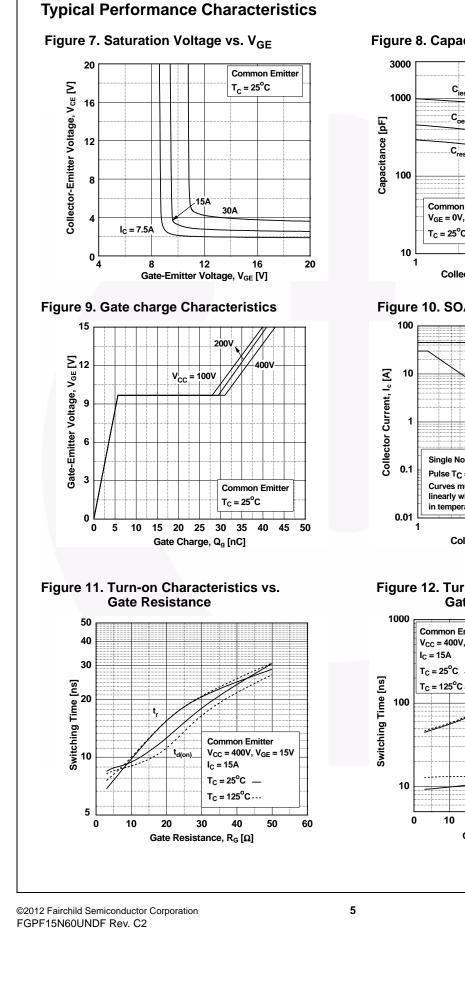
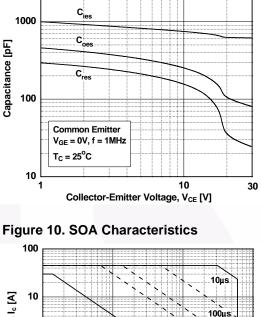


Figure 8. Capacitance Characteristics



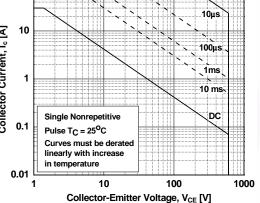
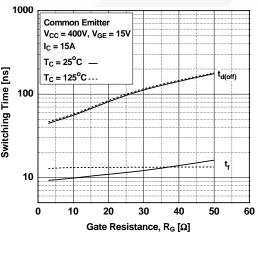
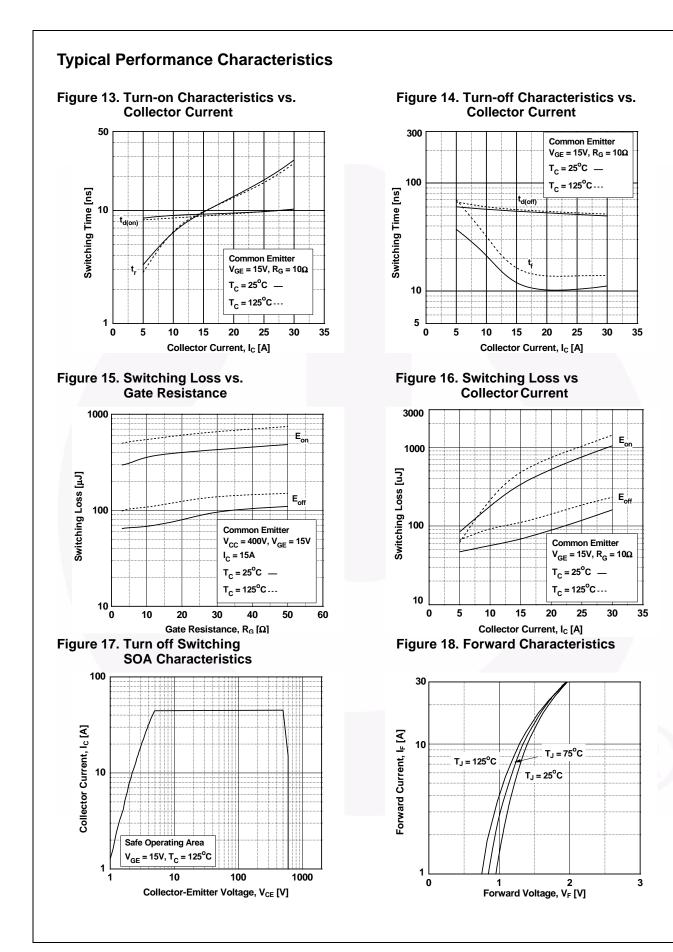


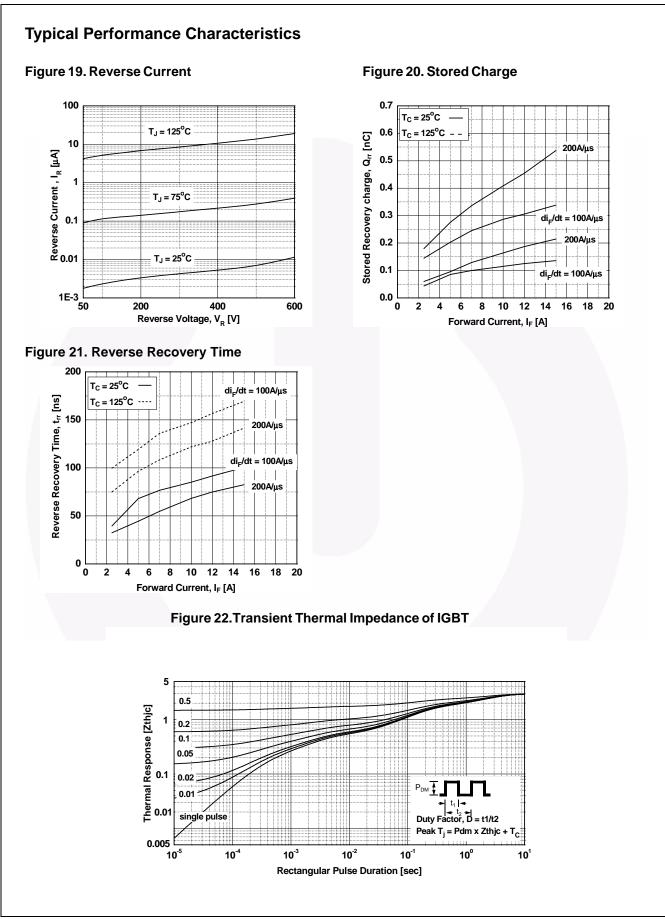
Figure 12. Turn-off Characteristics vs. Gate Resistance

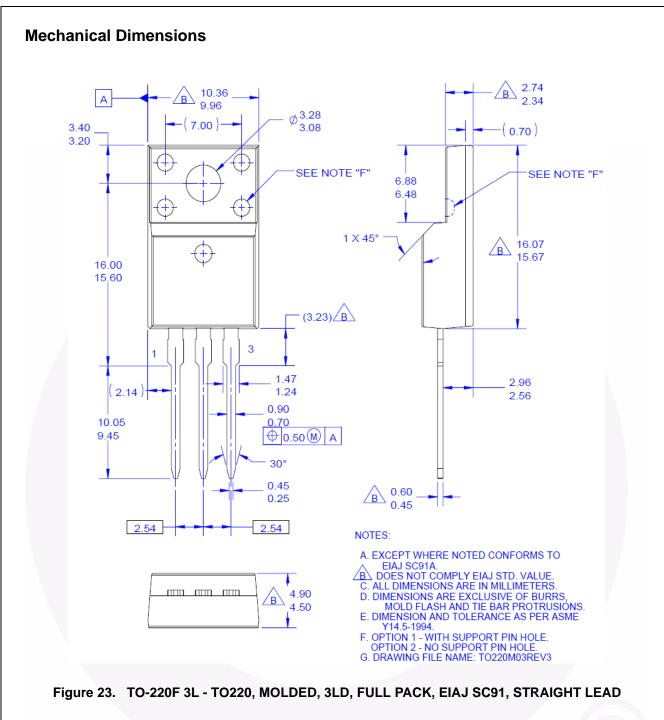


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Dimensions in Millimeters

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